

March 2013

# FDA28N50F

# N-Channel UniFET<sup>TM</sup> FRFET<sup>®</sup> MOSFET 500 V, 28 A, 175 m $\Omega$

#### **Features**

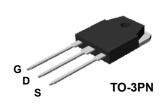
- $R_{DS(on)}$  = 140 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V,  $I_{D}$  = 14 A
- Low Gate Charge (Typ. 80 nC)
- Low C<sub>rss</sub> (Typ. 38 pF)
- · 100% Avalanche Tested
- · Improved dv/dt Capability
- · RoHS Compliant

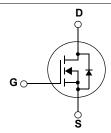
# **Applications**

- PDP TV
- · Uninterruptible Power Supply
- · AC-DC Power Supply

# **Description**

UniFET<sup>TM</sup> MOSFET is Fairchild Semiconductor<sup>®</sup>'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. The body diode's reverse recovery performance of UniFET FRFET<sup>®</sup> MOSFET has been enhanced by lifetime control. Its t<sub>rr</sub> is less than 100nsec and the reverse dv/dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





# MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter			FDA28N50F	Unit
V <sub>DSS</sub>	Drain to Source Voltage			500	V
V <sub>GSS</sub>	Gate to Source Voltage			±30	V
	Drain Current	- Continuous (T <sub>C</sub> = 25°C)		28	А
I <sub>D</sub>	Diam Current	- Continuous (T <sub>C</sub> = 100°C)		17	^
$I_{DM}$	Drain Current	- Pulsed	(Note 1)	112	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	2352	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	28	Α
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	31	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20	V/ns
D	Dower Dissinction	$(T_C = 25^{\circ}C)$		310	W
$P_{D}$	Power Dissipation	- Derate above 25°C		2.5	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

#### **Thermal Characteristics**

Symbol	Parameter	FDA28N50F	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.4	
$R_{\theta CS}$	Thermal Resistance, Case to Sink, Typ. 0.24		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

# **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDA28N50F	FDA28N50F	TO-3PN	-	-	30

# Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	eteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A$ , $V_{GS} = 0 V$ , $T_J = 25 ^{\circ} C$	500	-	-	V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, Referenced to 25°C	-	0.7	-	V/°C
1	Zara Cata Valtaga Prain Current	V <sub>DS</sub> = 500V, V <sub>GS</sub> = 0V	-	-	1	^
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 400V, T_C = 125^{\circ}C$	-	-	10	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	±100	nA

#### On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	3.0	-	5.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 14A	-	0.140	0.175	Ω
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20V, I_{D} = 14A$	-	35	-	S

## **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V f = 1MHz		3975	5387	pF
C <sub>oss</sub>	Output Capacitance			566	753	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			38	56	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V		-	80	105	nC
$Q_{gs}$	Gate to Source Gate Charge	$V_{DS} = 400V, I_{D} = 28A$	-	22	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	$V_{GS} = 10V$ (Note 4)	-	31	-	nC

#### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time			-	67	145	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>DD</sub> = 250V, I <sub>D</sub> = 28A		-	137	285	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$R_G = 25\Omega$		-	192	395	ns
t <sub>f</sub>	Turn-Off Fall Time		(Note 4)	-	101	212	ns

#### **Drain-Source Diode Characteristics**

$I_S$	Maximum Continuous Drain to Source Diode Forward Current		-	-	28	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	112	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 28A	-	-	1.5	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 28A	-	266	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	-	1.38	-	μС

#### Notes:

- Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 6mH, I $_{AS}$  = 28A, V $_{DD}$  = 50V, R $_{G}$  = 25 $\Omega$ , Starting T $_{J}$  = 25°C
- 3. I  $_{SD} \leq$  28A, di/dt  $\leq$  200A/µs, V  $_{DD} \leq$  BV  $_{DSS}$ , Starting T  $_{J}$  = 25°C
- 4. Essentially Independent of Operating Temperature Typical Characteristics

# **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

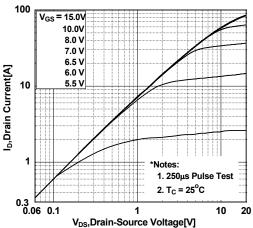


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

0.30

Drain-Source On-Resistance

0.10

 $R_{DS(ON)}$   $[\Omega]$ ,



100

Figure 5. Capacitance Characteristics

50

I<sub>D</sub>, Drain Current [A]

25

V<sub>GS</sub> = 10V

 $V_{GS} = 20V$ 

\*Note: T<sub>J</sub> = 25°C

75

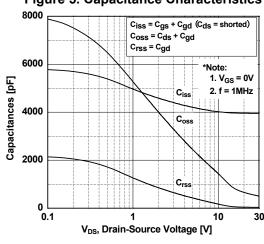


Figure 2. Transfer Characteristics

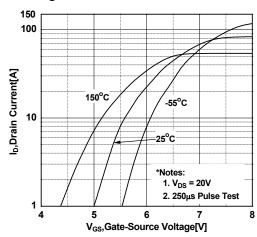


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

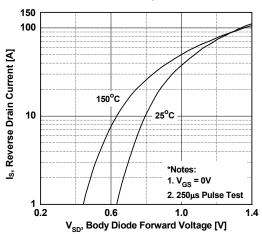
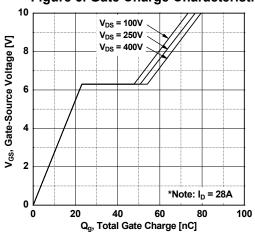


Figure 6. Gate Charge Characteristics



# **Typical Performance Characteristics** (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

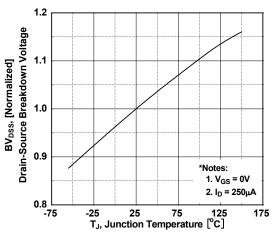


Figure 8. On-Resistance Variation vs. Temperature

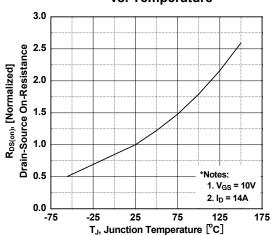
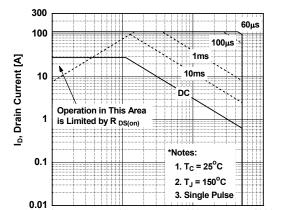


Figure 9. Maximum Safe Operating Area



100

V<sub>DS</sub>, Drain-Source Voltage [V]

1000

Figure 10. Maximum Drain Current vs. Case Temperature

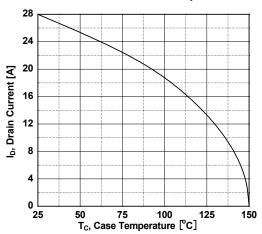
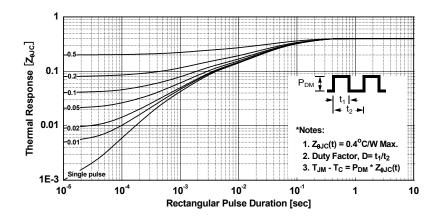
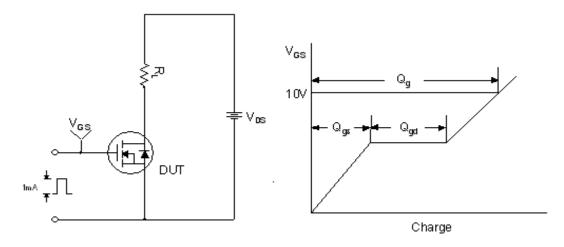


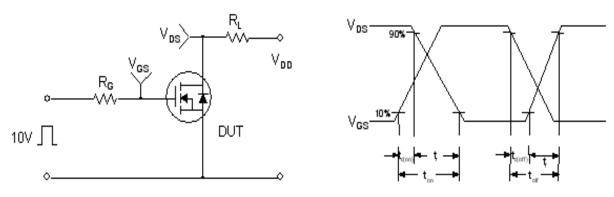
Figure 11. Transient Thermal Response Curve



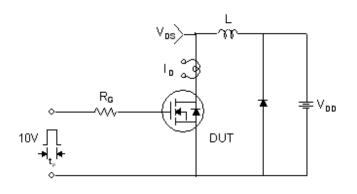
## **Gate Charge Test Circuit & Waveform**

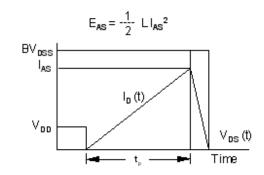


#### **Resistive Switching Test Circuit & Waveforms**

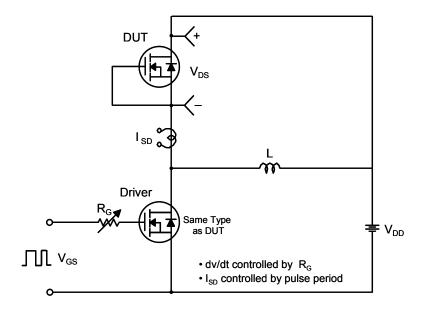


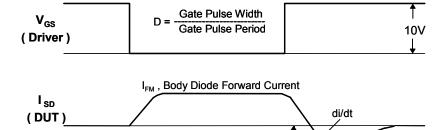
**Unclamped Inductive Switching Test Circuit & Waveforms** 





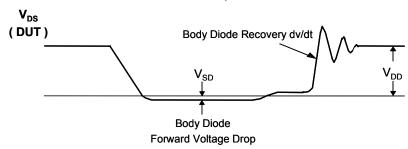
#### Peak Diode Recovery dv/dt Test Circuit & Waveforms





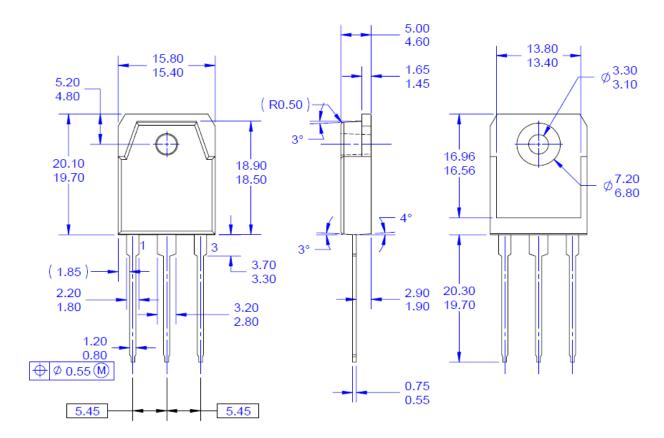


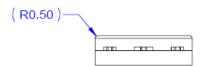
 $I_{RM}$ 



#### **Mechanical Dimensions**

# TO-3PN





#### NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO EIAJ SC-65 PACKAGING STANDARD.

  B) ALL DIMENSIONS ARE IN MILLIMETERS.
  C) DIMENSION AND TOLERANCING PER
- ASME14.5
- D) DIMENSIONS ARE EXCLUSSIVE OF BURRS,
- MOLD FLASH, AND TIE BAR EXTRUSSIONS.
  E) THIS PACKAGE IS INTENDED ONLY FOR TO3PN.
  F) DRAWING FILE NAME: TO3P03AREV4.

**Dimensions in Millimeters** 





#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool™ AccuPower™ AX-CAP® BitSiC™ Build it Now™ CorePLUS™ CorePOWER™  $CROSSVOLT^{\text{TM}}$ 

Current Transfer Logic™ **DEUXPEED**®

Dual Cool™ EcoSPARK® EfficentMax™ ESBC™

Fairchild<sup>®</sup>

Fairchild Semiconductor® FACT Quiet Series™ FACT<sup>®</sup>

FAST® FastvCore™ FETBench™ FPS™ F-PFS™ FRFET®

Global Power Resource<sup>SM</sup> Green Bridge™

Green FPS™ Green FPS™ e-Series™

GTO™ IntelliMAX™ ISOPLANAR™

MegaBuck™ MICROCOUPLER™ MicroFET™

MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ mWSaver™ OptoHiT™

Marking Small Speakers Sound Louder and Better™

OPTOLOGIC® OPTOPLANAR® (1)<sub>®</sub> PowerTrench® PowerXS™

Programmable Active Droop™

QFĔT® QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

STEALTH™ SuperFET® SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS®

SyncFET™

SYSTEM ®' 5GENERAL TinyBoost™ TinyBuck™ TinyCalc™ TinyLogic® TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC®

Sync-Lock™

TriFault Detect™ TRUECURRENT®\* սSerDes™

UHC® Ultra FRFET™ UniFET™ **VCX**<sup>TM</sup> VisualMax™ VoltagePlus™ XS™

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN. WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY
FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 164